

LOCTITE ECCOBOND UF 3812

December 2017

PRODUCT DESCRIPTION

LOCTITE ECCOBOND UF 3812 provides the following product characteristics:

Technology	Epoxy
Appearance	Black liquid
Cure	Heat cure
Product Benefits	<ul style="list-style-type: none">• Halogen-free• High Tg• Easy rework• One component• Room temperature flow capability• Excellent thermal cycle performance• Compatible with most Pb-free solders• Stable electrical performance under thermal/humidity bias
Application	Underfill, Encapsulant
Typical Package Application	CSP, WLCSP and BGA

LOCTITE ECCOBOND UF 3812 reworkable epoxy underfill is designed for CSP, WLCSP and BGA applications. This low viscosity material is formulated to flow at room temperature with no additional preheating required. It cures quickly at moderate temperatures to minimize stress to other components. This material's high glass transition temperature and high fracture toughness enables excellent protection of solder joints during thermal cycling.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity, Physica CP50-1, 25 °C, mPa·s (cP):	
@ Shear rate of 1,000 s ⁻¹	350
Specific Gravity	1.23
Pot Life @ 25°C, (<50% viscosity increase), days	3
Work Life @ 25°C, days	1
Shelf Life @ -20°C, days	180
Flash Point - See SDS	

TYPICAL CURING PERFORMANCE

Cure Schedule

>10 minutes @ 130°C

The above cure profile is a guideline recommendation. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties

Coefficient of Thermal Expansion , TMA:

Below Tg, ppm/°C	48
Above Tg, ppm/°C	175

Glass Transition Temperature (Tg) by TMA, °C

Storage Modulus, DMA, 3-point bending:

@ 25°C	N/mm ²	3,004
	(psi)	(435,580)

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GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

THAWING:

1. Allow container to reach room temperature before use.
2. After removing from the freezer, set the syringes to stand vertically while thawing.
3. DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
4. DO NOT re-freeze. Once thawed to 25°C, the adhesive should not be re-frozen.
5. Typical thaw times are listed as follows:
 - 2 hours for 30/55 cc syringes
 - 4 to 5 hours for 6 ounce cartridges

STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -20°C. Storage below -40°C or above -15 °C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.



Conversions

(°C x 1.8) + 32 = °F
kV/mm x 25.4 = V/mil
mm / 25.4 = inches
N x 0.225 = lb
N/mm x 5.71 = lb/in
psi x 145 = N/mm²
MPa = N/mm²
N·m x 8.851 = lb·in
N·m x 0.738 = lb·ft
N·mm x 0.142 = oz·in
mPa·s = cP

Disclaimer

Note:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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